



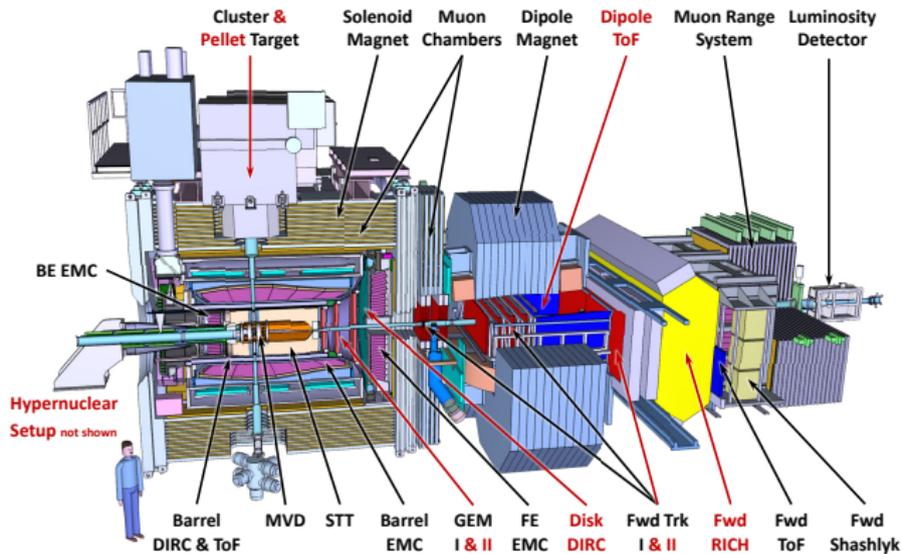
# Pixels in $\overline{\text{PANDA}}$

## 1st Pixel Platform Workshop

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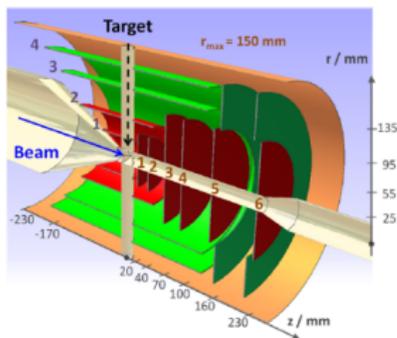
# The $\bar{\text{PANDA}}$ Detector



## $\bar{\text{PANDA}}$ physics program:

- Hadron spectroscopy
- Hadron structure
- Hadrons in medium
- Hypernuclear physics

# Micro Vertex Detector



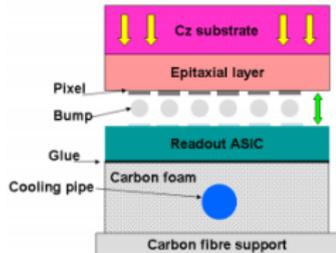
## Barrel:

- Layer 1: radius 28 mm, Pixel Detector
- Layer 2: radius 53 mm, Pixel Detector
- Layer 3: radius 92 mm, Strip Detector
- Layer 4: radius 120 mm, Strip Detector

## Forward:

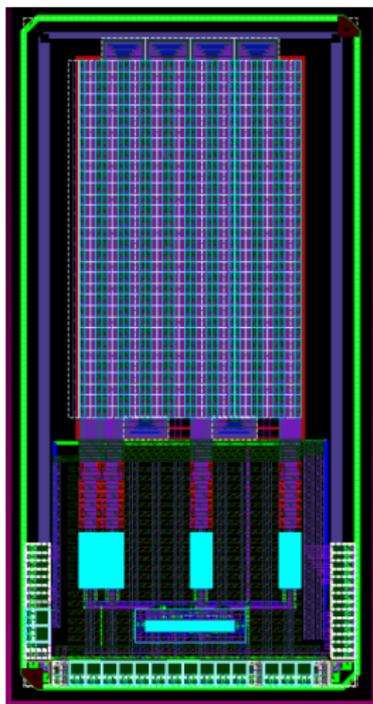
- Disks 1-2 : radius 37.5 mm, Pixels
- Disks 3-4 : radius 75 mm, Pixels
- Disks 5-6 : radius 130 mm, Pixels + Strips

# Pixel Sensor for MVD



- $116 \times 110$  Pixels
- Pixel size"  $100 \times 100 \mu\text{m}^2$
- Active area:  $11.4 \times 11.6 \text{ mm}^2$
- dE/dx measurement: ToT, 12bits dynamic range
- Time resolution: 6.25 ns (1.80 ns r.m.s.)

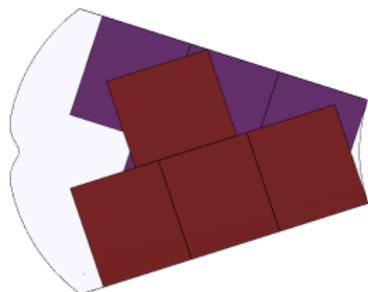
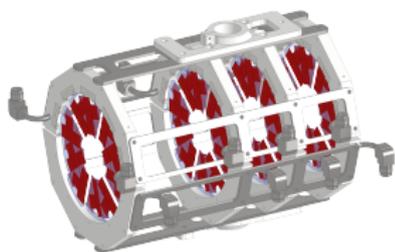
## Readout ASIC: ToPiX v4



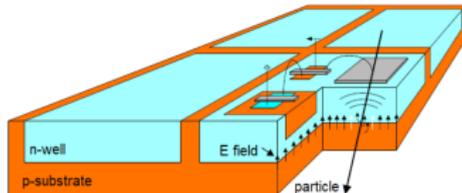
- Size: 3 mm × 6 mm
- CMOS 130 nm
- 640 pixel cells,  $2 \times 2 \times 128$  and  $2 \times 2 \times 32$  columns
- Hamming encoding and TMR pixel logic protection schemes
- Clock frequency 160 MHz
- SEU protected EoC
- Serial data output
- GBT-compatible SLVD I/O
- Project discontinued in  $\sim$  2014

# Luminosity Detector

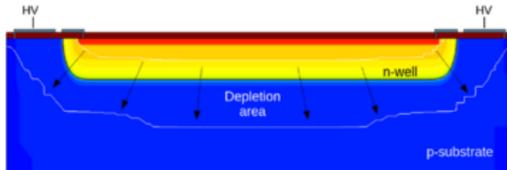
- Reconstruct tracks of elastically scattered antiprotons to determine luminosity at IP
- Resolution limited by multiple scattering
  - ⇒ Low material budget
  - ⇒ Sensors in vacuum
- Four detector layers with 10 sensor modules each
- Aluminum holding structure with embedded stainless steel pipes for cooling



# High Voltage Monolithic Active Pixel Sensor (HV-MAPS)

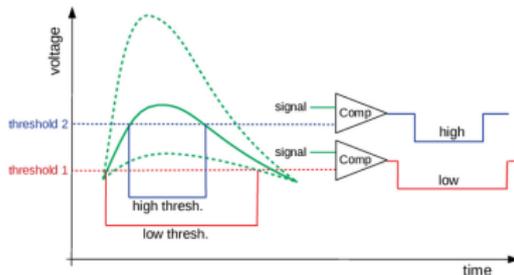
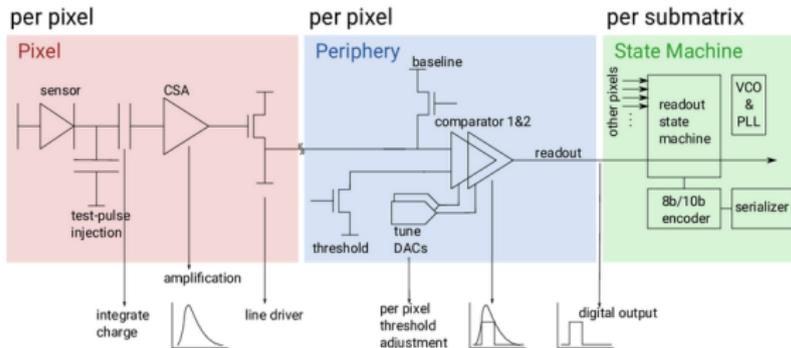


I. Perić, NIM A 582 (2007), 876 – 885



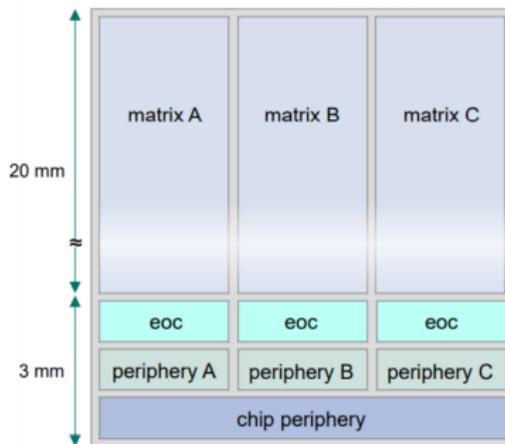
- Sensitive volume and readout electronics on same chip
- Pixels implemented as deep n-wells in a p-substrate
- 180 nm HVCMOS
- Depletion layer by applying high reverse bias voltage
- Fast charge collection via drift
- Depletion layer thickness: 10 – 15  $\mu\text{m}$
- Sensor thickness:  $\sim 70 \mu\text{m}$

# High Voltage Monolithic Active Pixel Sensor (HV-MAPS)



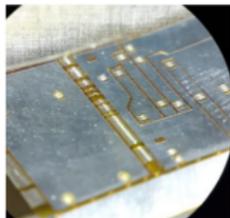
- 2 Thresholds
- Low thresholds locks timestamp
- High threshold “verifies” hit

# HV-MAPS in $\bar{P}$ ANDA



	MuPix11	P2Pix
Pixels	$256 \times 250$	$244 \times 240$
Pixel size	$80 \times 80 \mu\text{m}^2$	$84 \times 84 \mu\text{m}^2$
Physical size	$20.7 \times 23.2 \text{ mm}^2$	$20.7 \times 22.6 \text{ mm}^2$
Active area	$20.0 \times 20.5 \text{ mm}^2$	
Comperators	Two in periphery	One in pixel cell

# Flexcable Unit

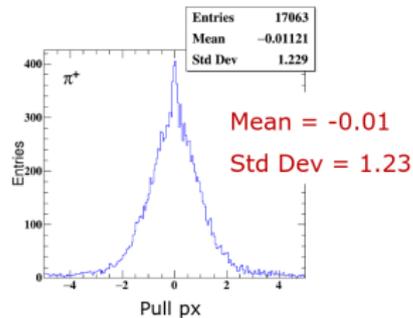
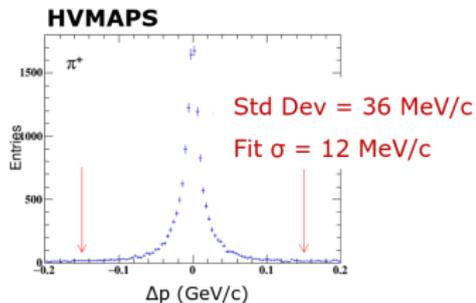
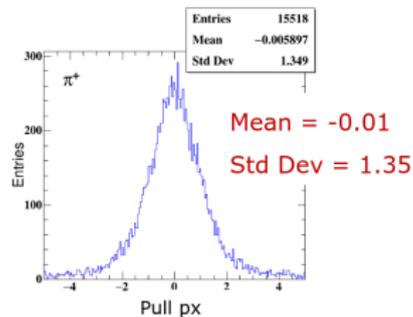
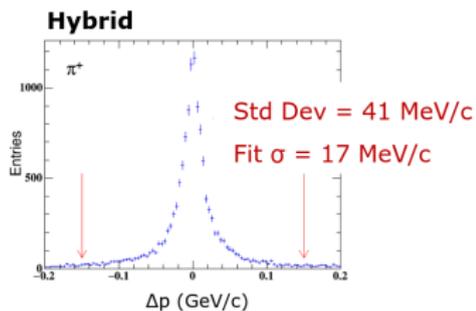


Aluminium flex cable from LTU in Ukraine  
Lower material budget than copper  $\Rightarrow$  less scattering  
Sensor and connector PCB tab bonded to cable

# Simulation study of reaction channel $\bar{p}p \rightarrow D^+ D^-$

- Investigate HV-MAPS as possible replacement
- Data set
  - ▶  $\bar{p}p \rightarrow D^+ D^-$   
with  $D^+ \rightarrow K^- \pi^+ \pi^+$  and  $D^- \rightarrow K^+ \pi^- \pi^-$
  - ▶  $p_{\text{beam}} = 8.9 \text{ GeV}/c$
  - ▶ 10000 events
- Event selection
  - ▶  $n \geq 6$  charged tracks
  - ▶ Ideal PID algorithm
  - ▶ Truth match ( $D/K/\pi$ ) depending on stage

# Momentum Resolution and Pulls

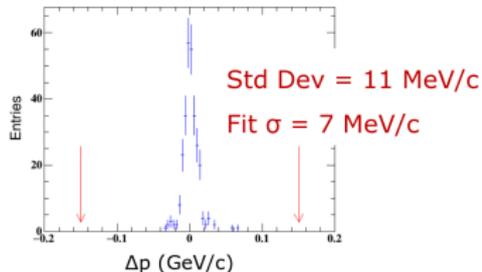


Resolution and Pulls ( $\pi^+$ ) better for HV-MAPS

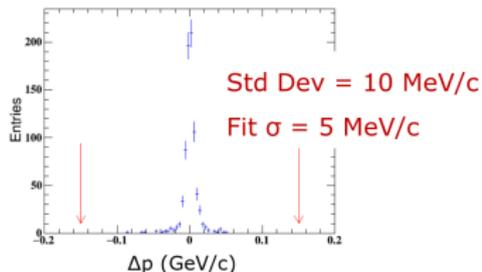
# Resolutions for $D^+$

## Momentum

Hybrid

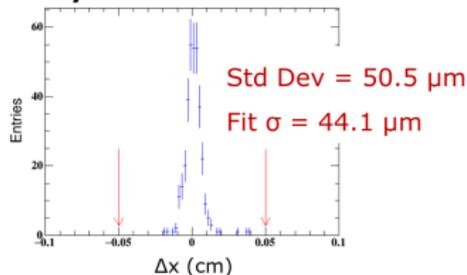


HVMAPS

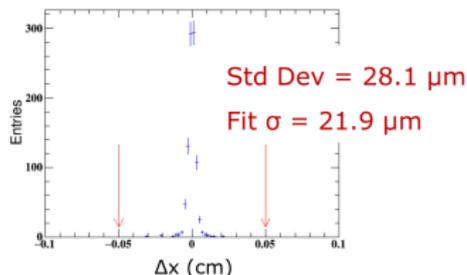


## Vertex (x)

Hybrid



HVMAPS



Slight improvement in momentum resolution (10%)  
Factor 2 in vertex resolution

- Two different types of Pixel sensors in  $\bar{\text{PANDA}}$ : HV-MAPs and hybrid Pixels
- Compared HV-MAPS and Hybrid Pixels in MVD:
  - ▶ Slightly less hits/clusters  $< 1\%$  with HV-MAPS (in MVD)
  - ▶ More tracks with HV-MAPS ( $\sim 10\%$ )
  - ▶ HV-MAPS offer better momentum resolution of  $K$  and  $\pi \sim 15\%$